

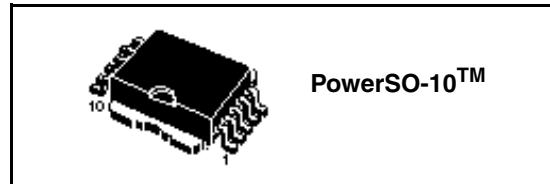
## Quad high side smart power solid state relay

### Features

| Type         | $V_{demag}$ <sup>(1)</sup> | $R_{DS(on)}$ <sup>(1)</sup> | $I_{out}$ <sup>(1)</sup> | $V_{CC}$ |
|--------------|----------------------------|-----------------------------|--------------------------|----------|
| VN340SP-33-E | $V_{CC}$ -55 V             | 0.2 Ω                       | 1 A                      | 36 V     |

1. Per channel.

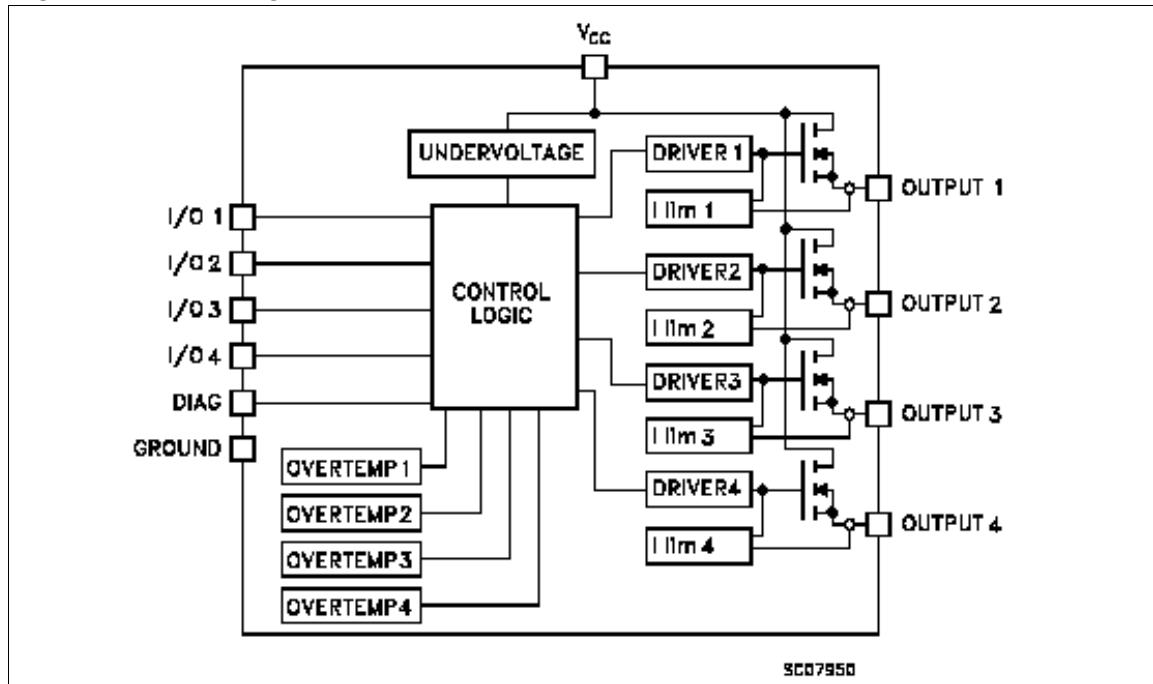
- Output current: 1 A per channel
- Digital I/O's clamped at 32 V minimum voltage
- Shorted load and overtemperature protections
- Protection against loss of ground
- Built-in current limiter
- Undervoltage shut-down
- Open drain diagnostic output
- Fast demagnetization of inductive loads
- Conforms to IEC 61131-2



### Description

The VN340SP-33-E is a monolithic device made using STMicroelectronics VIPower technology, intended for driving four independent resistive or inductive loads with one side connected to ground. Active current limitation avoids dropping the system power supply in case of shorted load. Built-in thermal shut-down protects the chip from overtemperature and short circuit. The open drain diagnostic output indicates overtemperature conditions. Each I/O is pulled down when overtemperature condition of the relative channel is verified.

**Figure 1. Block diagram**



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# 1 Maximum ratings

**Table 1. Absolute maximum rating**

| Symbol     | Parameter  | Values             | Unit             |
|------------|--|--------------------|------------------|
| $V_{CC}$   | Power supply voltage   | 45                 | V                |
| $-V_{CC}$  | Reverse supply voltage   | -4                 | V                |
| $I_{OUT}$  | Output current (continuos)   | Internally limited | A                |
| $I_R$      | Reverse output current (per channel)   | -6                 | A                |
| $I_{IN}$   | Input current (per channel)  | $\pm 10$           | mA               |
| $I_{DIAG}$ | Diag pin current   | $\pm 10$           | mA               |
| $V_{ESD}$  | Electrostatic discharge ( $R = 1.5 \text{ k}\Omega$ ; $C = 100 \text{ pF}$ )     | 2000               | V                |
| $E_{AS}$   | Single pulse avalanche energy per channel not simultaneously<br><i>Figure 4.</i> | 400                | mJ               |
| $P_{tot}$  | Power dissipation at $T_c = 25^\circ\text{C}$                                    | Internally limited | w                |
| $T_J$      | Junction operating temperature   | Internally limited | $^\circ\text{C}$ |
| $T_{STG}$  | Storage temperature  | -55 to 150         | $^\circ\text{C}$ |

**Table 2. Thermal data**

| Symbol     | Parameter  | Values | Unit               |
|------------|--|--------|--------------------|
| $R_{thJC}$ | Thermal resistance junction-case <sup>(1)</sup>    | Max    | $^\circ\text{C/W}$ |
| $R_{thJA}$ | Thermal resistance junction-ambient <sup>(2)</sup> | Max    | $^\circ\text{C/W}$ |

1. Per channel

2. When mounted using minimum recommended pad size on FR-4 board

## 2 Pin connections

Figure 2. Connection diagram (top view)

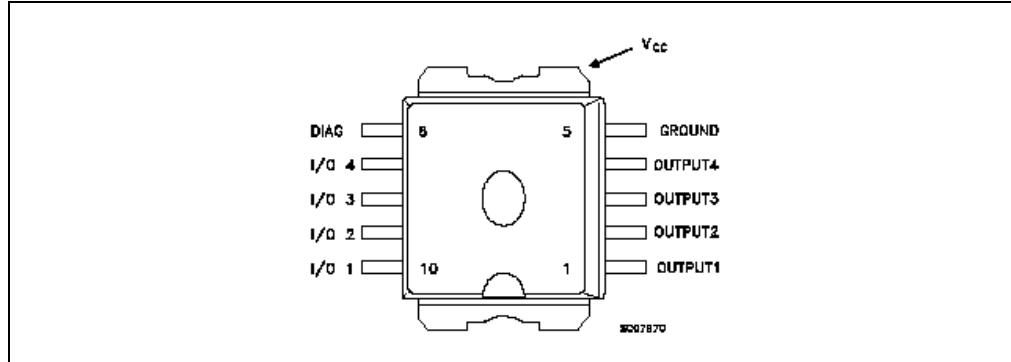
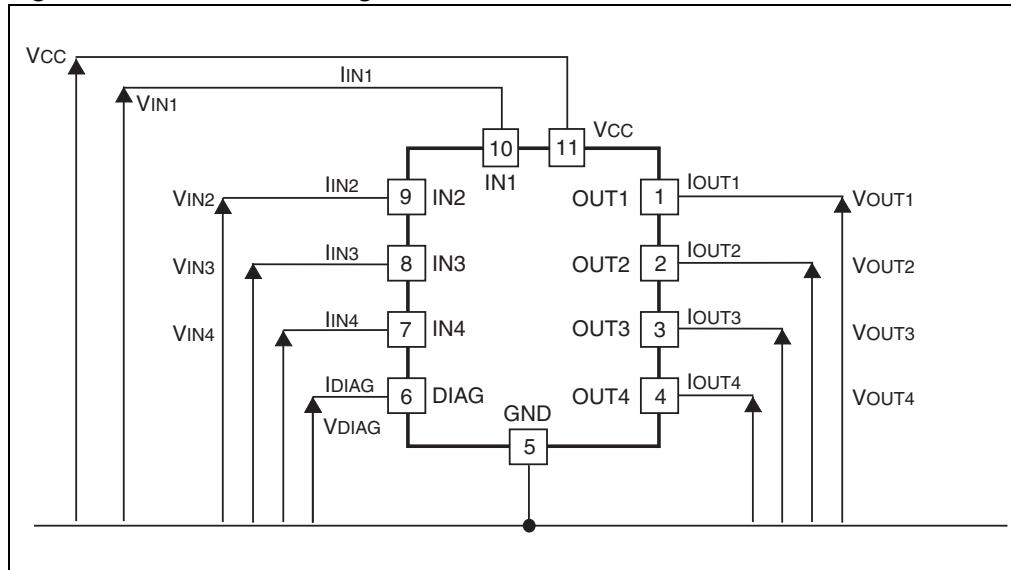


Figure 3. Current and voltage conventions



### 3 Electrical characteristics

$10 \text{ V} < V_{CC} < 36 \text{ V}$ ;  $-40^\circ\text{C} < T_J < 125^\circ\text{C}$ ; unless otherwise specified

**Table 3. Power section**

| Symbol      | Parameter                  | Test conditions  | Min              | Typ              | Max                | Unit                             |
|-------------|----------------------------|--|------------------|------------------|--------------------|----------------------------------|
| $V_{CC}$    | Supply voltage             |  | 10               |                  | 36                 | V                                |
| $R_{ON}$    | On state resistance        | $I_{OUT} = 0.5 \text{ A}; T_J = 25^\circ\text{C}$<br>$I_{OUT} = 0.5 \text{ A}; T_J = 85^\circ\text{C}$<br>$I_{OUT} = 0.5 \text{ A}; T_J = 125^\circ\text{C}$ |                  |                  | 0.2<br>0.32<br>0.4 | $\Omega$<br>$\Omega$<br>$\Omega$ |
| $I_S$       | Supply current             | All channels OFF<br>On state; $V_{IN} = 30 \text{ V}$ ; $I_{OUT} = 0 \text{ V}$<br>( $T_J = 125^\circ\text{C}$ )   |                  |                  | 1<br>6             | mA<br>mA                         |
| $V_{OL}$    | Low state output voltage   | $V_{IN} = V_{IL}$ ; $R_{LOAD} \geq 10 \text{ M}\Omega$   |                  |                  | 1.5                | V                                |
| $V_{demag}$ | Output voltage at turn-off | $I_{OUT} = 0.5 \text{ A}; L_{LOAD} \geq 1 \text{ mH}$  | $V_{CC^-}$<br>65 | $V_{CC^-}$<br>55 | $V_{CC^-}$<br>45   | V                                |
| $I_{LGND}$  | Output current at turn-off | $V_{CC} = V_{INn} = V_{GND} = V_{STAT} = 18 \text{ to } 30 \text{ V}$<br>$T_A = -25^\circ\text{C} \text{ to } 85^\circ\text{C}$ <i>Figure 6.</i>             |                  |                  | 2                  | mA                               |

**Table 4. Switching ( $V_{CC} = 24 \text{ V}$ )**

| Symbol       | Parameter                             | Test conditions   | Min | Typ | Max | Unit          |
|--------------|---------------------------------------|---|-----|-----|-----|---------------|
| $t_{d(ON)}$  | Turn-on delay time of Output current  | $I_{OUT} = 0.5 \text{ A}$ , resistive load input rise time $< 0.1 \mu\text{s}$ , $T_J = 25^\circ\text{C}$ |     | 52  | 100 | $\mu\text{s}$ |
| $t_r$        | Rise time of output current           | $I_{OUT} = 0.5 \text{ A}$ , resistive load input rise time $< 0.1 \mu\text{s}$ , $T_J = 25^\circ\text{C}$ |     | 94  | 250 | $\mu\text{s}$ |
| $t_{d(OFF)}$ | Turn-off delay time of output current | $I_{OUT} = 0.5 \text{ A}$ , resistive load input rise time $< 0.1 \mu\text{s}$ , $T_J = 25^\circ\text{C}$ |     | 34  | 50  | $\mu\text{s}$ |
| $t_f$        | Fall time of output current           | $I_{OUT} = 0.5 \text{ A}$ , resistive load input rise time $< 0.1 \mu\text{s}$ , $T_J = 25^\circ\text{C}$ |     | 8   | 20  | $\mu\text{s}$ |

**Table 5. Logical input**

| Symbol        | Parameter                        | Test conditions                                     | Min | Typ        | Max | Unit          |
|---------------|----------------------------------|---|-----|------------|-----|---------------|
| $V_{IL}$      | I/O input low level voltage      |   |     |            | 2   | V             |
| $V_{IH}$      | I/O input high level voltage (1) |   | 3.5 |            |     | V             |
| $V_{I(HYST)}$ | I/O input hysteresis voltage     |   |     | 0.5        |     | V             |
| $I_{IN}$      | I/O input current                | $V_{IN} = 30 \text{ V}$                             |     |            | 25  | $\mu\text{A}$ |
| $V_{ICL}$     | I/O input clamp voltage (1)      | $I_{IN} = 1 \text{ mA}$<br>$I_{IN} = -1 \text{ mA}$ | 32  | 36<br>-0.7 |     | V<br>V        |

- The input voltage is internally clamped at 32 V minimum, it is possible to connect the input pins to an higher voltage via an external resistor calculate to not exceed 10 mA



**Table 6. Protection and diagnostic**

| Symbol           | Parameter                        | Test conditions  | Min | Typ        | Max | Unit               |
|------------------|----------------------------------|--|-----|------------|-----|--------------------|
| $V_{DIAG}^{(1)}$ | Status voltage output low        | $I_{DIAG} = 5 \text{ mA}$ (Fault condition)  |     |            | 1   | V                  |
| $V_{SCL}^{(1)}$  | Status clamp voltage             | $I_{DIAG} = 1 \text{ mA}$<br>$I_{DIAG} = 1 \text{ mA}$                                 | 32  | 36<br>-0.7 |     | V<br>V             |
| $V_{USD}$        | Undervoltage shut down           |  | 5   |            | 8   | V                  |
| $I_{LIM}$        | DC Short circuit current         | $V_{CC} = 24 \text{ V}$ ; $R_{LOAD} < 10 \text{ m}\Omega$                              | 1   |            | 2   | A                  |
| $I_{OVPK}$       | Peak short circuit current       | $V_{CC} = 24 \text{ V}$ ; $V_{IN} = 30 \text{ V}$ ;<br>$R_{LOAD} < 10 \text{ m}\Omega$ |     |            | 4   | A                  |
| $I_{DIAGH}$      | Leakage ondiag pin in high state | $V_{DIAG} = 24 \text{ V}$  |     |            | 25  | $\mu\text{A}$      |
| $I_{LOAD}$       | Output leakage current           | $V_{CC} = 10 \text{ to } 36 \text{ V}$ ; $V_{IN} = V_{IL}$                             |     |            | 50  | $\mu\text{A}$      |
| $t_{SC}$         | Delay time of current limiter    |  |     |            | 100 | $\mu\text{s}$      |
| $T_{TSD}$        | Thermal shut down temperature    |  | 150 | 170        |     | $^{\circ}\text{C}$ |
| $T_R$            | Thermal reset temperature        |  | 135 | 155        |     | $^{\circ}\text{C}$ |

1. Status determination  $> 100 \mu\text{s}$  after the switching edge.

**Note:** If INPUT pin is floating the corresponding channel will automatically switch OFF. If GND pin is disconnected, the channel will switch OFF provided  $V_{CC}$  not exceed 36 V.

## 4 Test circuits

Figure 4. Avalanche energy test circuit

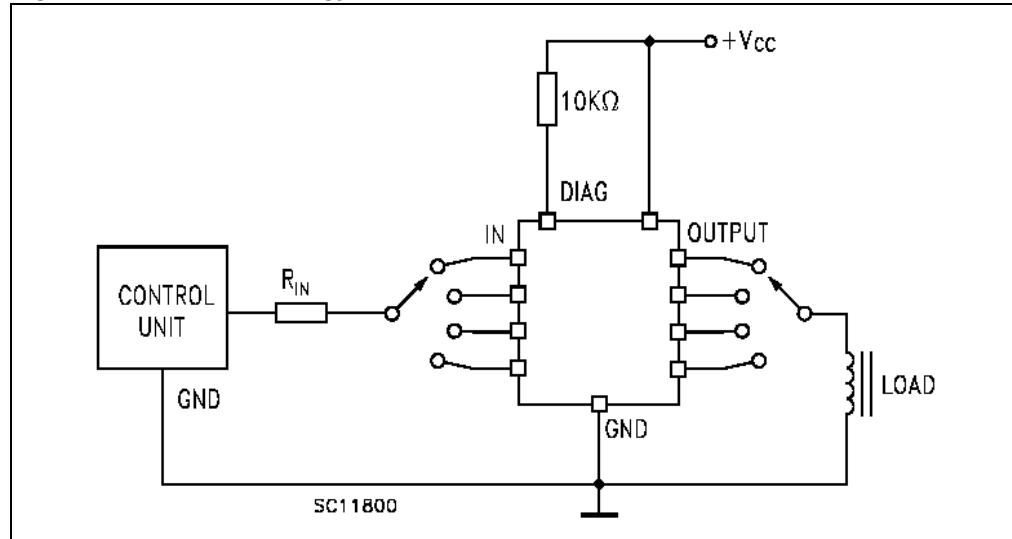
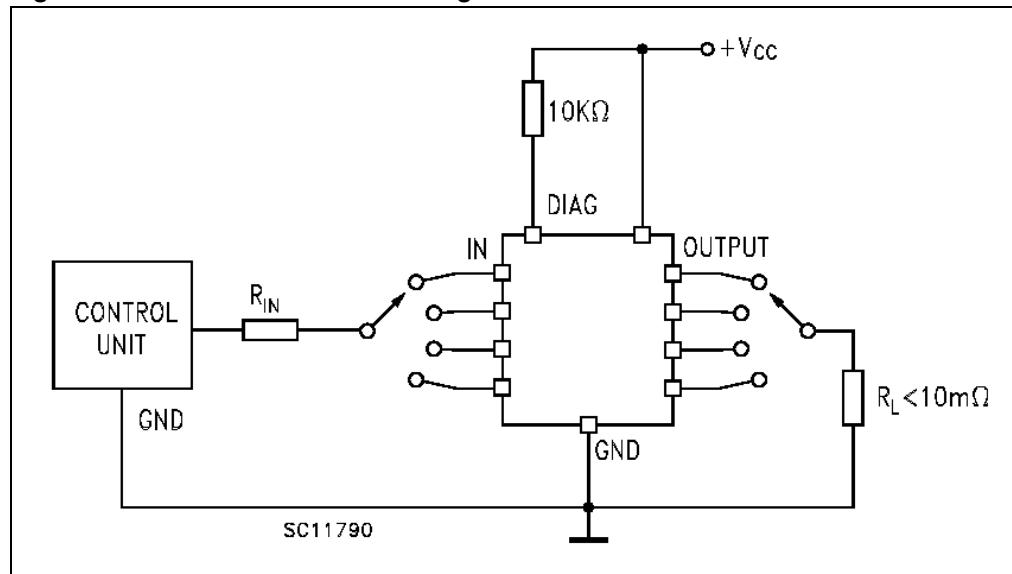
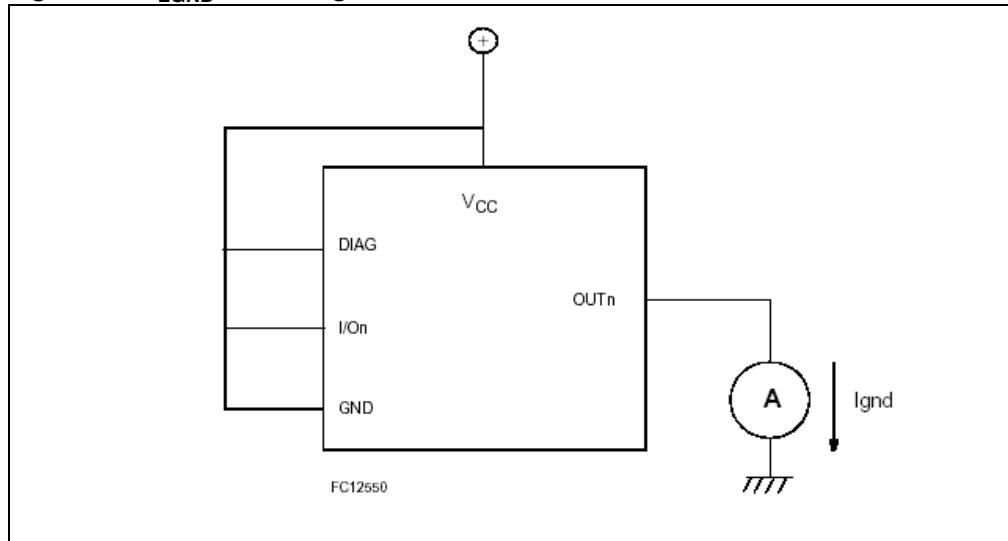


Figure 5. Peak short circuit test diagram



**Figure 6.**  $I_{LGND}$  test configuration

## 5 Switching time waveforms and truth table

Figure 7. Switching waveforms

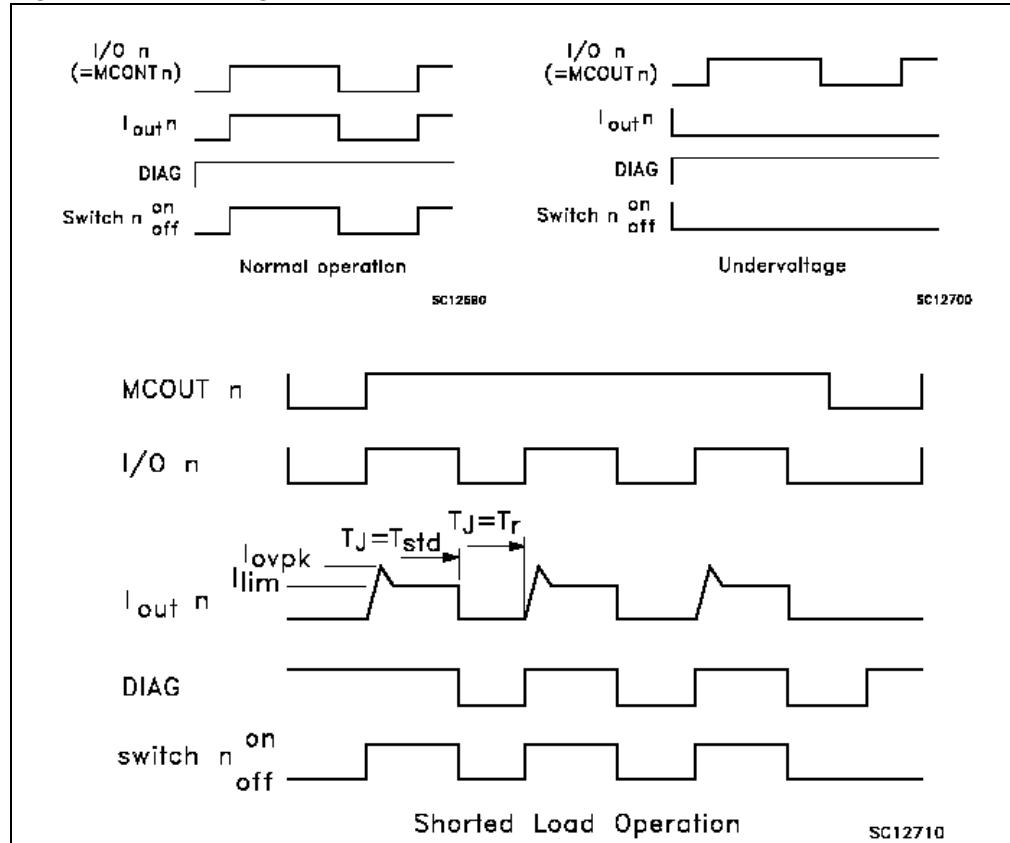
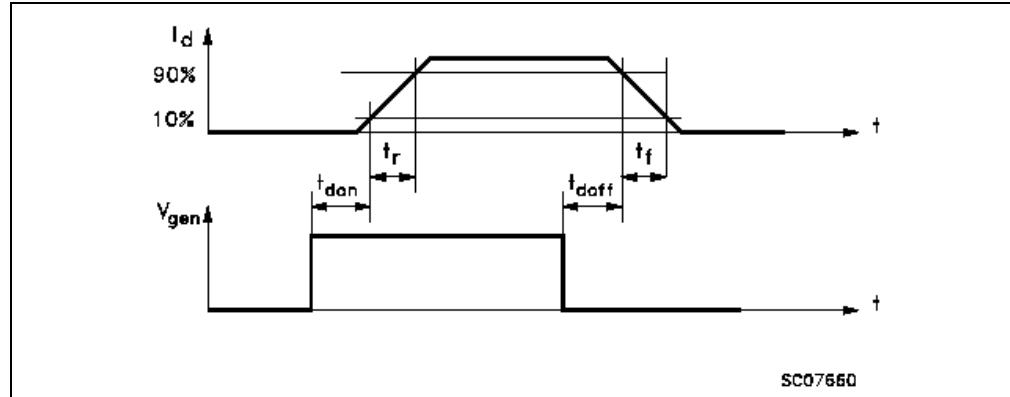
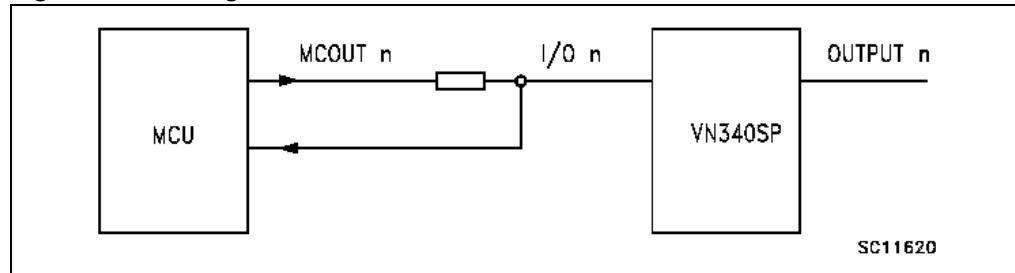


Figure 8. Switching parameter test conditions



**Table 7. Truth table**

|                                      | MCOUTn | I/On | OUTPUTn | Diagnostic |
|--------------------------------------|--------|------|---------|------------|
| Normal operation                     | L      | L    | L       | H          |
|                                      | H      | H    | H       | H          |
| Overtemperature                      | L      | L    | L       | H          |
|                                      | H      | L    | L       | L          |
| Undervoltage                         | L      | L    | L       | H          |
|                                      | H      | H    | L       | H          |
| Shorted load<br>(Current limitation) | L      | L    | L       | H          |
|                                      | H      | H    | H       | H          |

**Figure 9. Driving circuit**

## 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)



**Table 8. PowerSO-10 mechanical data**

| Dim | Mm    |      |       | Inch  |       |       |
|-----|-------|------|-------|-------|-------|-------|
|     | Min   | Typ  | Max   | Min   | Typ   | Max   |
| A   | 3.35  |      | 3.65  | 0.132 |       | 0.144 |
| A1  | 0.00  |      | 0.10  | 0.000 |       | 0.004 |
| B   | 0.40  |      | 0.60  | 0.016 |       | 0.024 |
| c   | 0.23  |      | 0.32  | 0.009 |       | 0.012 |
| D   | 9.40  |      | 9.60  | 0.370 |       | 0.378 |
| D1  | 7.40  |      | 7.60  | 0.291 |       | 0.300 |
| E   | 9.30  |      | 9.50  | 0.366 |       | 0.374 |
| E1  | 7.20  |      | 7.40  | 0.283 |       | 0.291 |
| E2  | 7.20  |      | 7.60  | 0.283 |       | 0.300 |
| E3  | 6.10  |      | 6.35  | 0.240 |       | 0.250 |
| E4  | 5.90  |      | 6.10  | 0.232 |       | 0.240 |
| e   |       | 1.27 |       |       | 0.050 |       |
| F   | 1.25  |      | 1.35  | 0.049 |       | 0.053 |
| H   | 13.80 |      | 14.40 | 0.543 |       | 0.567 |
| h   |       | 0.50 |       |       | 0.002 |       |
| L   | 1.20  |      | 1.80  | 0.047 |       | 0.071 |
| q   |       | 1.70 |       |       | 0.067 |       |
| a   | 0°    |      | 8°    |       |       |       |

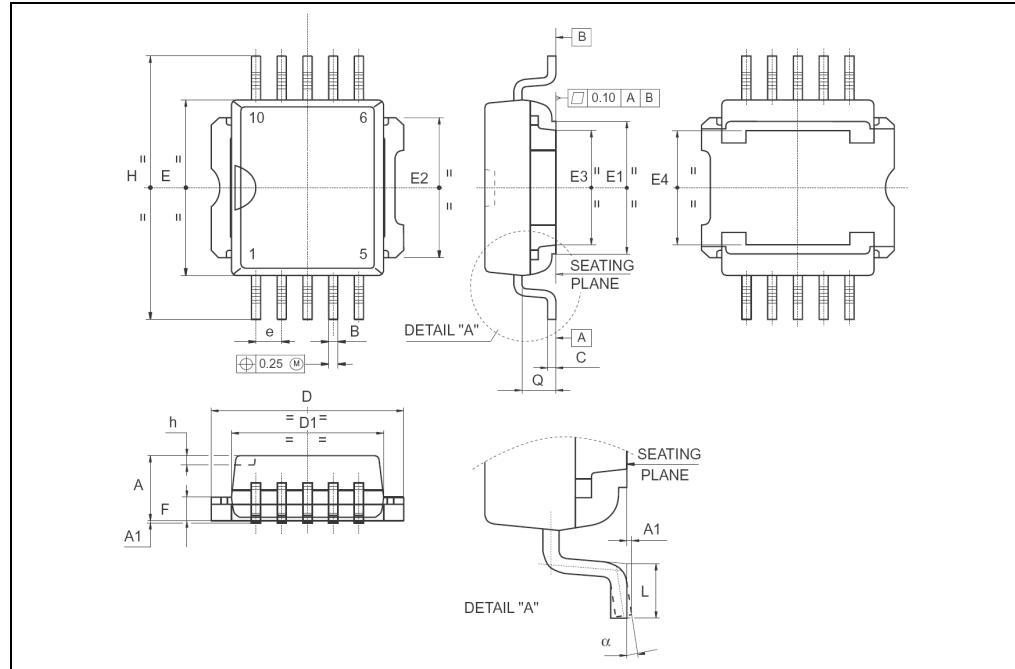
**Figure 10. Package dimension**

Figure 11. PowerSO-10™ suggested pad and tube shipment (No suffix)

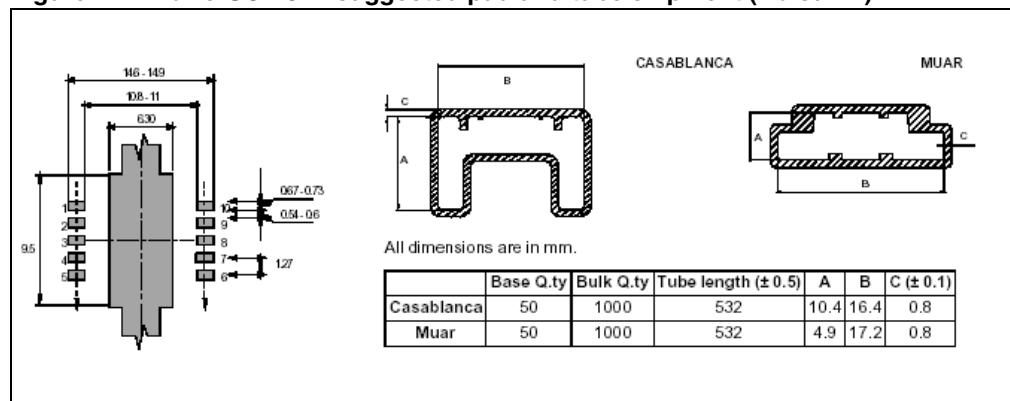
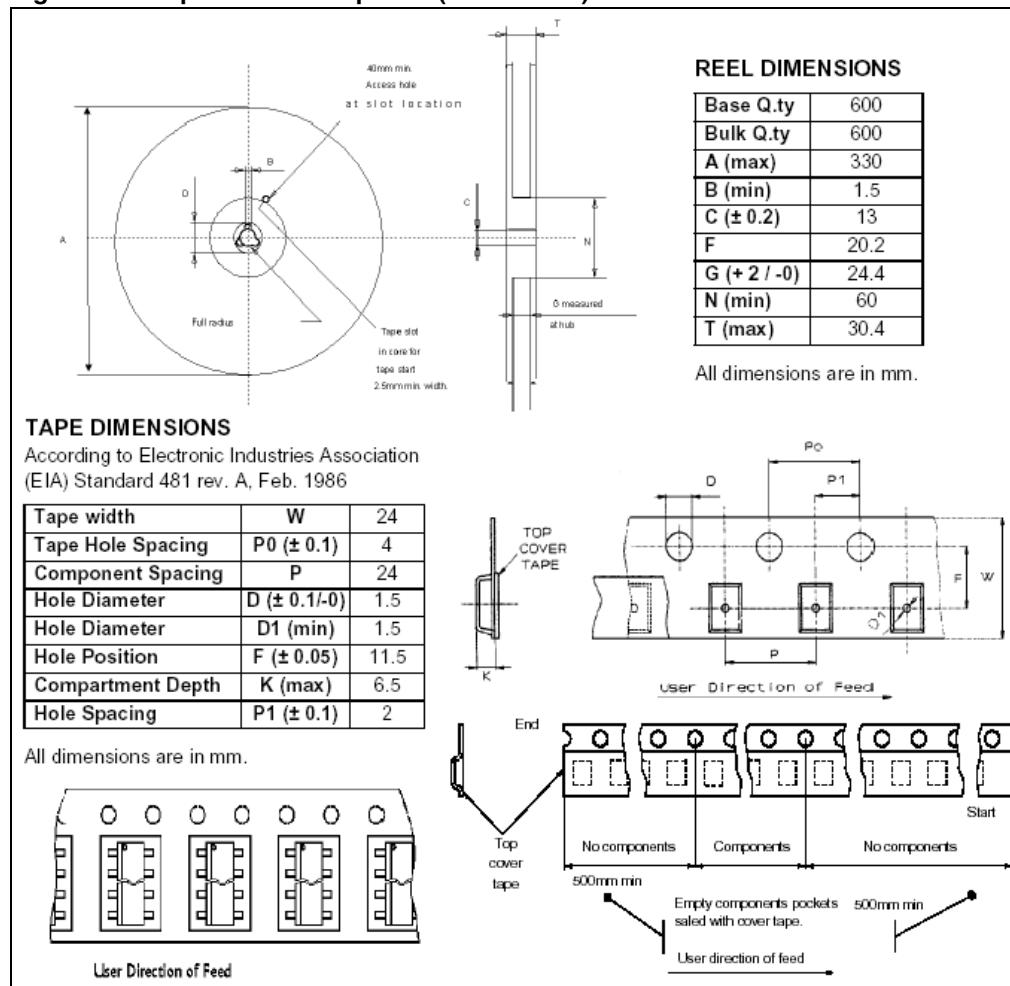


Figure 12. Tape and reel shipment (Suffix "TR")



## 7 Order codes

**Table 9. Order codes**

| Order codes    | Package                  | Packaging     |
|----------------|--------------------------|---------------|
| VN340SP-33-E   | PowerSO-10 <sup>TM</sup> | Tube          |
| VN340SPTR-33-E |                          | Tape and reel |

## 8 Revision history

**Table 10. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 5-Sep-2005  | 1        | Final release   |
| 19-Mar-2007 | 2        | Document reformatted, typo in <i>Note 1 on page 6</i> |
| 22-Aug-2008 | 3        | Updated <i>Table 9</i>                                |



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